

STARPOWER

SEMICONDUCTOR

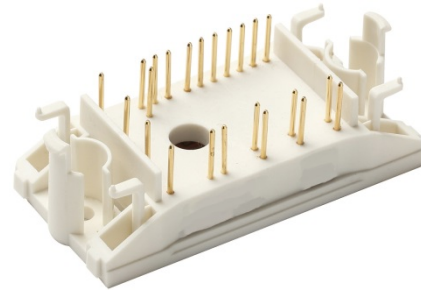
IGBT

GD10PJY65F4S

650V/10A PIM in one-package

General Description

STARPOWER IGBT Power Module provides ultra low conduction loss as well as short circuit ruggedness. They are designed for the applications such as general inverters and UPS.



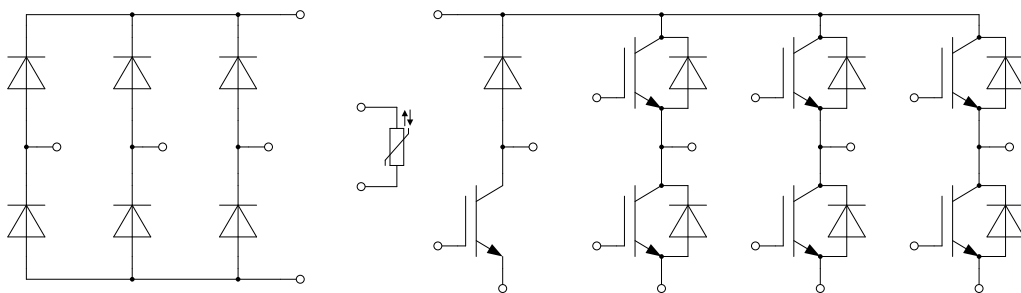
Features

- Low $V_{CE(sat)}$ Trench IGBT technology
- 6 μ s short circuit capability
- $V_{CE(sat)}$ with positive temperature coefficient
- Maximum junction temperature 175°C
- Low inductance case
- Fast & soft reverse recovery anti-parallel FWD
- Isolated heatsink using DBC technology

Typical Applications

- Inverter for motor drive
- AC and DC servo drive amplifier
- Uninterruptible power supply

Equivalent Circuit Schematic



Absolute Maximum Ratings $T_C=25^{\circ}\text{C}$ unless otherwise noted**IGBT-inverter**

Symbol	Description	Value	Unit
V_{CES}	Collector-Emitter Voltage	650	V
V_{GES}	Gate-Emitter Voltage	± 20	V
I_C	Collector Current @ $T_C=25^{\circ}\text{C}$	20	A
	@ $T_C=100^{\circ}\text{C}$	10	A
I_{CM}	Pulsed Collector Current $t_p=1\text{ms}$	20	A
P_D	Maximum Power Dissipation @ $T_j=175^{\circ}\text{C}$	66	W

Diode-inverter

Symbol	Description	Value	Unit
V_{RRM}	Repetitive Peak Reverse Voltage	650	V
I_F	Diode Continuous Forward Current	10	A
I_{FM}	Diode Maximum Forward Current $t_p=1\text{ms}$	20	A

Diode-rectifier

Symbol	Description	Value	Unit
V_{RRM}	Repetitive Peak Reverse Voltage	1600	V
I_O	Average Output Current 50Hz/60Hz,sine wave	10	A
I_{FSM}	Surge Forward Current $V_R=0\text{V}, t_p=10\text{ms}, T_j=45^{\circ}\text{C}$	270	A
I^2t	I^2t -value, $V_R=0\text{V}, t_p=10\text{ms}, T_j=45^{\circ}\text{C}$	360	A^2s

IGBT-brake

Symbol	Description	Value	Unit
V_{CES}	Collector-Emitter Voltage	650	V
V_{GES}	Gate-Emitter Voltage	± 20	V
I_C	Collector Current @ $T_C=25^{\circ}\text{C}$	20	A
	@ $T_C=100^{\circ}\text{C}$	10	A
I_{CM}	Pulsed Collector Current $t_p=1\text{ms}$	20	A
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Diode-brake

Symbol	Description	Value	Unit
V_{RRM}	Repetitive Peak Reverse Voltage	650	V
I_F	Diode Continuous Forward Current	10	A
I_{FM}	Diode Maximum Forward Current $t_p=1\text{ms}$	20	A

Module

Symbol	Description	Value	Unit
T_{jmax}	Maximum Junction Temperature(inverter,brake)	175	$^{\circ}\text{C}$
	Maximum Junction Temperature(rectifier)	150	$^{\circ}\text{C}$
T_{jop}	Operating Junction Temperature	-40 to +150	$^{\circ}\text{C}$
T_{STG}	Storage Temperature Range	-40 to +125	$^{\circ}\text{C}$
V_{ISO}	Isolation Voltage RMS, $f=50\text{Hz}, t=1\text{min}$	4000	V

IGBT-inverter Characteristics $T_C=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit	
$V_{CE(sat)}$	Collector to Emitter Saturation Voltage	$I_C=10\text{A}, V_{GE}=15\text{V}, T_j=25^\circ\text{C}$		1.45	1.90	V	
		$I_C=10\text{A}, V_{GE}=15\text{V}, T_j=125^\circ\text{C}$		1.60			
		$I_C=10\text{A}, V_{GE}=15\text{V}, T_j=150^\circ\text{C}$		1.70			
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$I_C=0.35\text{mA}, V_{CE}=V_{GE}, T_j=25^\circ\text{C}$	5.1	5.8	6.5	V	
I_{CES}	Collector Cut-Off Current	$V_{CE}=V_{CES}, V_{GE}=0\text{V}, T_j=25^\circ\text{C}$			1.0	mA	
I_{GES}	Gate-Emitter Leakage Current	$V_{GE}=V_{GES}, V_{CE}=0\text{V}, T_j=25^\circ\text{C}$			400	nA	
R_{Gint}	Internal Gate Resistance			0		Ω	
C_{ies}	Input Capacitance	$V_{CE}=25\text{V}, f=1\text{MHz}, V_{GE}=0\text{V}$		0.50		nF	
C_{res}	Reverse Transfer Capacitance				0.02		nF
Q_G	Gate Charge	$V_{GE}=-15\dots+15\text{V}$		0.09		μC	
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=300\text{V}, I_C=10\text{A}, R_G=27\Omega, V_{GE}=\pm 15\text{V}, T_j=25^\circ\text{C}$		9		ns	
t_r	Rise Time			7		ns	
$t_{d(off)}$	Turn-Off Delay Time			60		ns	
t_f	Fall Time			72		ns	
E_{on}	Turn-On Switching Loss			0.08		mJ	
E_{off}	Turn-Off Switching Loss			0.22		mJ	
$t_{d(on)}$	Turn-On Delay Time		$V_{CC}=300\text{V}, I_C=10\text{A}, R_G=27\Omega, V_{GE}=\pm 15\text{V}, T_j=125^\circ\text{C}$		10		ns
t_r	Rise Time				10		ns
$t_{d(off)}$	Turn-Off Delay Time			72		ns	
t_f	Fall Time			111		ns	
E_{on}	Turn-On Switching Loss			0.12		mJ	
E_{off}	Turn-Off Switching Loss			0.27		mJ	
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=300\text{V}, I_C=10\text{A}, R_G=27\Omega, V_{GE}=\pm 15\text{V}, T_j=150^\circ\text{C}$			10		ns
t_r	Rise Time				11		ns
$t_{d(off)}$	Turn-Off Delay Time			75		ns	
t_f	Fall Time			115		ns	
E_{on}	Turn-On Switching Loss			0.13		mJ	
E_{off}	Turn-Off Switching Loss			0.29		mJ	
I_{SC}	SC Data		$t_p \leq 6\mu\text{s}, V_{GE}=15\text{V}, T_j=150^\circ\text{C}, V_{CC}=360\text{V}, V_{CEM} \leq 650\text{V}$		50		A

Diode-inverter Characteristics $T_C=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
V_F	Diode Forward Voltage	$I_F=10\text{A}, V_{GE}=0\text{V}, T_j=25^\circ\text{C}$		1.60	2.05	V
		$I_F=10\text{A}, V_{GE}=0\text{V}, T_j=125^\circ\text{C}$		1.55		
		$I_F=10\text{A}, V_{GE}=0\text{V}, T_j=150^\circ\text{C}$		1.50		
Q_r	Recovered Charge	$V_R=300\text{V}, I_F=10\text{A},$ $-di/dt=1650\text{A}/\mu\text{s}, V_{GE}=-15\text{V}$ $T_j=25^\circ\text{C}$		0.6		μC
I_{RM}	Peak Reverse Recovery Current			20		A
E_{rec}	Reverse Recovery Energy			0.12		mJ
Q_r	Recovered Charge	$V_R=300\text{V}, I_F=10\text{A},$ $-di/dt=1650\text{A}/\mu\text{s}, V_{GE}=-15\text{V}$ $T_j=125^\circ\text{C}$		0.9		μC
I_{RM}	Peak Reverse Recovery Current			21		A
E_{rec}	Reverse Recovery Energy			0.22		mJ
Q_r	Recovered Charge	$V_R=300\text{V}, I_F=10\text{A},$ $-di/dt=1650\text{A}/\mu\text{s}, V_{GE}=-15\text{V}$ $T_j=150^\circ\text{C}$		1.2		μC
I_{RM}	Peak Reverse Recovery Current			23		A
E_{rec}	Reverse Recovery Energy			0.29		mJ

Diode-rectifier Characteristics $T_C=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
V_F	Diode Forward Voltage	$I_F=10\text{A}, V_{GE}=0\text{V}, T_j=150^\circ\text{C}$		0.88		V
I_R	Reverse Current	$T_j=150^\circ\text{C}, V_R=1600\text{V}$			1.0	mA

IGBT-brake Characteristics $T_C=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit	
$V_{CE(sat)}$	Collector to Emitter Saturation Voltage	$I_C=10\text{A}, V_{GE}=15\text{V}, T_j=25^\circ\text{C}$		1.45	1.90	V	
		$I_C=10\text{A}, V_{GE}=15\text{V}, T_j=125^\circ\text{C}$		1.60			
		$I_C=10\text{A}, V_{GE}=15\text{V}, T_j=150^\circ\text{C}$		1.70			
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$I_C=0.35\text{mA}, V_{CE}=V_{GE}, T_j=25^\circ\text{C}$	5.1	5.8	6.5	V	
I_{CES}	Collector Cut-Off Current	$V_{CE}=V_{CES}, V_{GE}=0\text{V}, T_j=25^\circ\text{C}$			1.0	mA	
I_{GES}	Gate-Emitter Leakage Current	$V_{GE}=V_{GES}, V_{CE}=0\text{V}, T_j=25^\circ\text{C}$			400	nA	
R_{Gint}	Internal Gate Resistance			0		Ω	
C_{ies}	Input Capacitance	$V_{CE}=25\text{V}, f=1\text{MHz}, V_{GE}=0\text{V}$		0.50		nF	
C_{res}	Reverse Transfer Capacitance				0.02		nF
Q_G	Gate Charge	$V_{GE}=-15\dots+15\text{V}$		0.09		μC	
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=300\text{V}, I_C=10\text{A}, R_G=27\Omega, V_{GE}=\pm 15\text{V}, T_j=25^\circ\text{C}$		9		ns	
t_r	Rise Time			7		ns	
$t_{d(off)}$	Turn-Off Delay Time			60		ns	
t_f	Fall Time			72		ns	
E_{on}	Turn-On Switching Loss			0.08		mJ	
E_{off}	Turn-Off Switching Loss			0.22		mJ	
$t_{d(on)}$	Turn-On Delay Time		$V_{CC}=300\text{V}, I_C=10\text{A}, R_G=27\Omega, V_{GE}=\pm 15\text{V}, T_j=125^\circ\text{C}$		10		ns
t_r	Rise Time				10		ns
$t_{d(off)}$	Turn-Off Delay Time			72		ns	
t_f	Fall Time			111		ns	
E_{on}	Turn-On Switching Loss			0.12		mJ	
E_{off}	Turn-Off Switching Loss			0.27		mJ	
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=300\text{V}, I_C=10\text{A}, R_G=27\Omega, V_{GE}=\pm 15\text{V}, T_j=150^\circ\text{C}$			10		ns
t_r	Rise Time				11		ns
$t_{d(off)}$	Turn-Off Delay Time			75		ns	
t_f	Fall Time			115		ns	
E_{on}	Turn-On Switching Loss			0.13		mJ	
E_{off}	Turn-Off Switching Loss			0.29		mJ	
I_{SC}	SC Data		$t_p \leq 6\mu\text{s}, V_{GE}=15\text{V}, T_j=150^\circ\text{C}, V_{CC}=360\text{V}, V_{CEM} \leq 650\text{V}$		50		A

Diode-brake Characteristics $T_C=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
V_F	Diode Forward Voltage	$I_F=10\text{A}, V_{GE}=0\text{V}, T_j=25^\circ\text{C}$		1.60	2.05	V
		$I_F=10\text{A}, V_{GE}=0\text{V}, T_j=125^\circ\text{C}$		1.55		
		$I_F=10\text{A}, V_{GE}=0\text{V}, T_j=150^\circ\text{C}$		1.50		
Q_r	Recovered Charge	$V_R=300\text{V}, I_F=10\text{A},$ $-di/dt=1650\text{A}/\mu\text{s}, V_{GE}=-15\text{V}$ $T_j=25^\circ\text{C}$		0.6		μC
I_{RM}	Peak Reverse Recovery Current			20		A
E_{rec}	Reverse Recovery Energy			0.12		mJ
Q_r	Recovered Charge	$V_R=300\text{V}, I_F=10\text{A},$ $-di/dt=1650\text{A}/\mu\text{s}, V_{GE}=-15\text{V}$ $T_j=125^\circ\text{C}$		0.9		μC
I_{RM}	Peak Reverse Recovery Current			21		A
E_{rec}	Reverse Recovery Energy			0.22		mJ
Q_r	Recovered Charge	$V_R=300\text{V}, I_F=10\text{A},$ $-di/dt=1650\text{A}/\mu\text{s}, V_{GE}=-15\text{V}$ $T_j=150^\circ\text{C}$		1.2		μC
I_{RM}	Peak Reverse Recovery Current			23		A
E_{rec}	Reverse Recovery Energy			0.29		mJ

NTC Characteristics $T_C=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
R_{25}	Rated Resistance			22.0		$\text{k}\Omega$
$\Delta R/R$	Deviation of R_{100}	$T_C=100^\circ\text{C}, R_{100}=1486.1\Omega$	-5		5	%
P_{25}	Power Dissipation				200	mW
$B_{25/50}$	B-value	$R_2=R_{25}\exp[B_{25/50}(1/T_2-1/(298.15\text{K}))]$		4000		K

Module Characteristics $T_C=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Min.	Typ.	Max.	Unit
R_{thJC}	Junction-to-Case (per IGBT-inverter)		2.049	2.254	K/W
	Junction-to-Case (per Diode-inverter)		2.946	3.241	
	Junction-to-Case (per Diode-rectifier)		1.475	1.623	
	Junction-to-Case (per IGBT-brake)		2.049	2.254	
	Junction-to-Case (per Diode-brake)		2.946	3.241	
R_{thCH}	Case-to-Heatsink (per IGBT-inverter)		0.727		K/W
	Case-to-Heatsink (per Diode-inverter)		1.046		
	Case-to-Heatsink (per Diode-rectifier)		0.524		
	Case-to-Heatsink (per IGBT-brake)		0.727		
	Case-to-Heatsink (per Diode-brake)		1.046		
	Case-to-Heatsink (per Module)		0.036		
M	Mounting Torque, Screw M4	2.0		2.2	N.m
G	Weight of Module		28		g

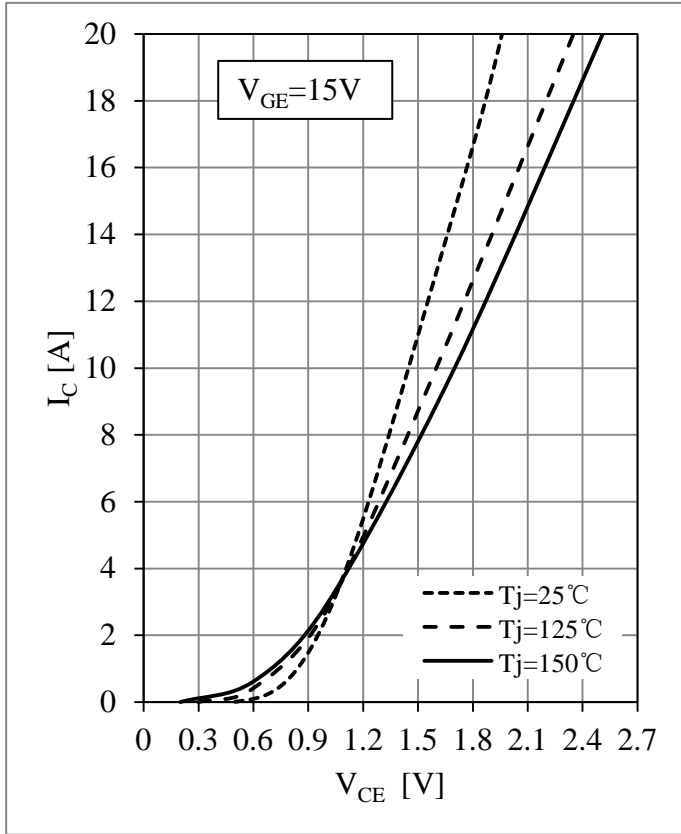


Fig 1. IGBT-inverter Output Characteristics

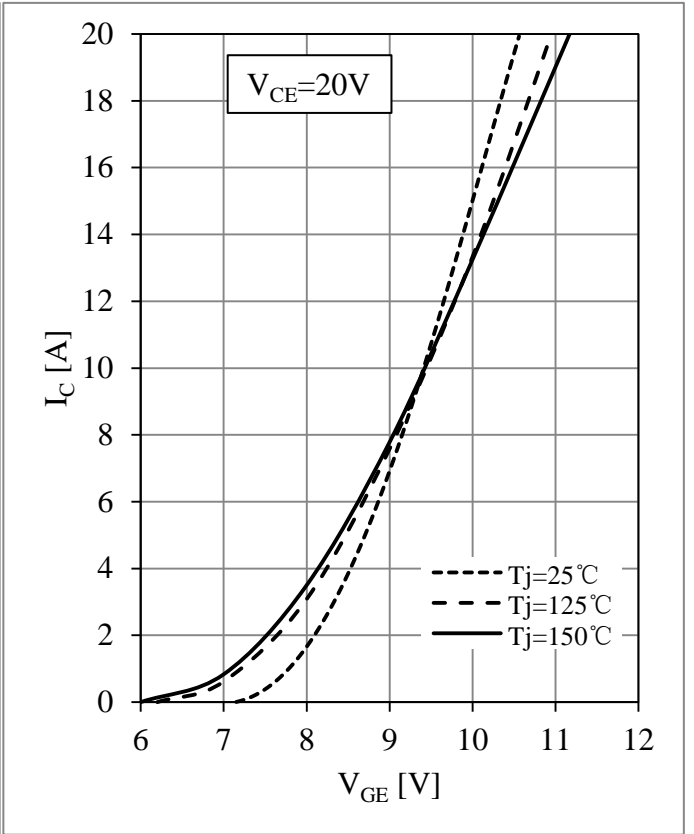


Fig 2. IGBT-inverter Transfer Characteristics

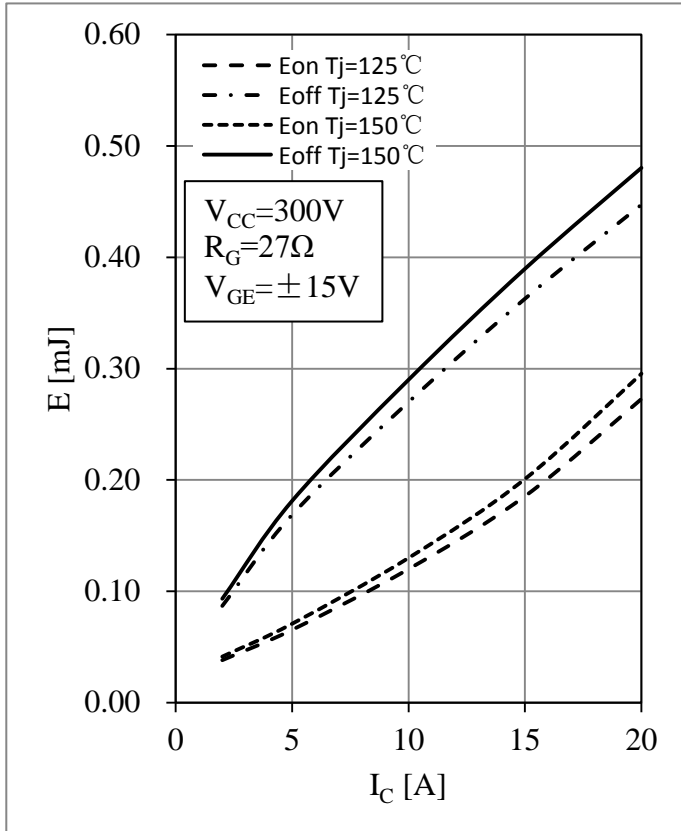


Fig 3. IGBT-inverter Switching Loss vs. I_c

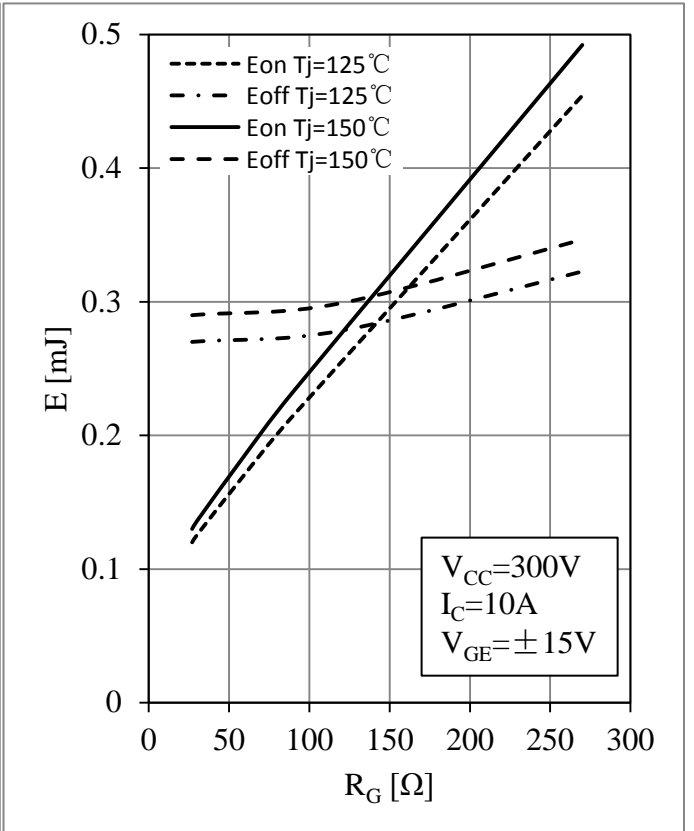


Fig 4. IGBT-inverter Switching Loss vs. R_g

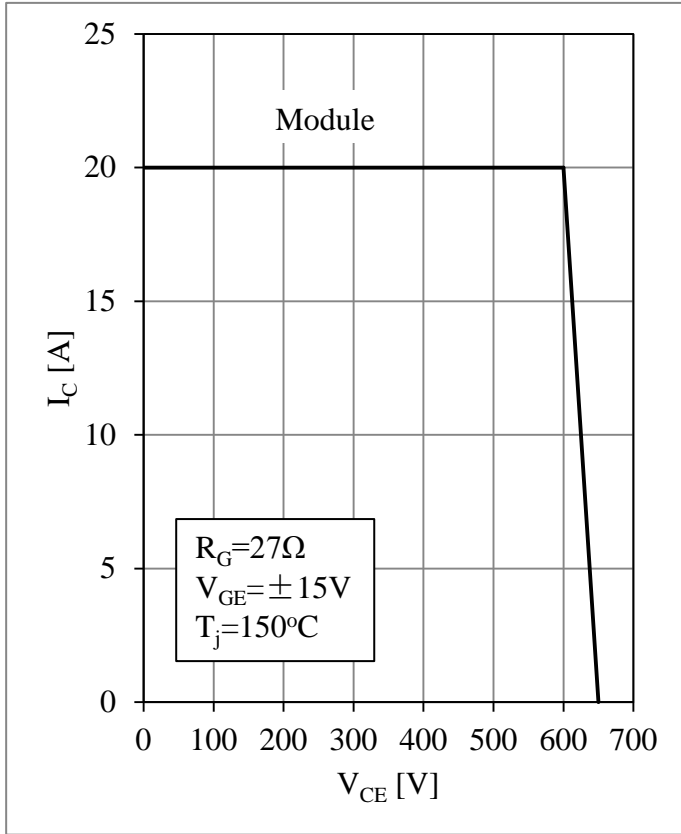


Fig 5. IGBT-inverter RBSOA

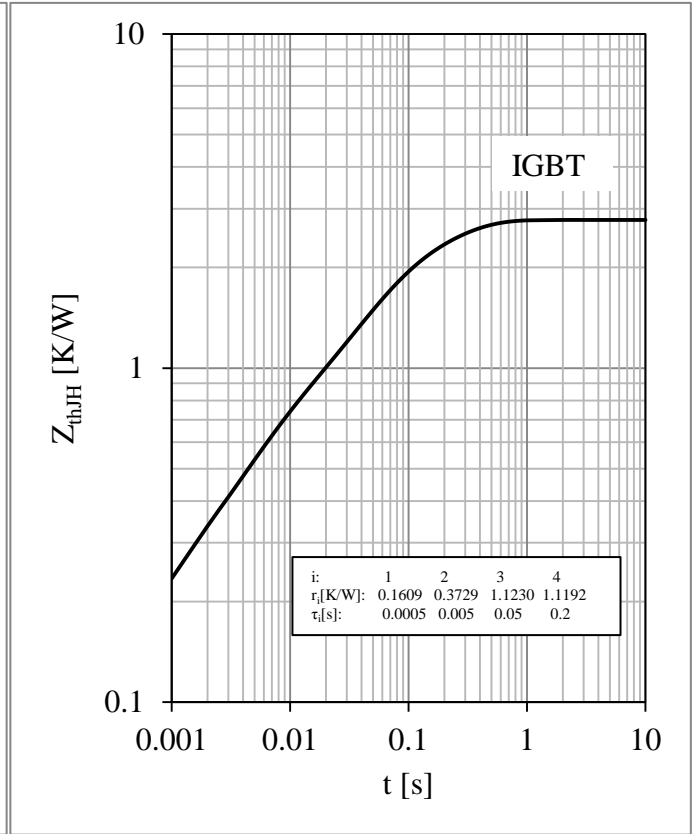


Fig 6. IGBT-inverter Transient Thermal Impedance

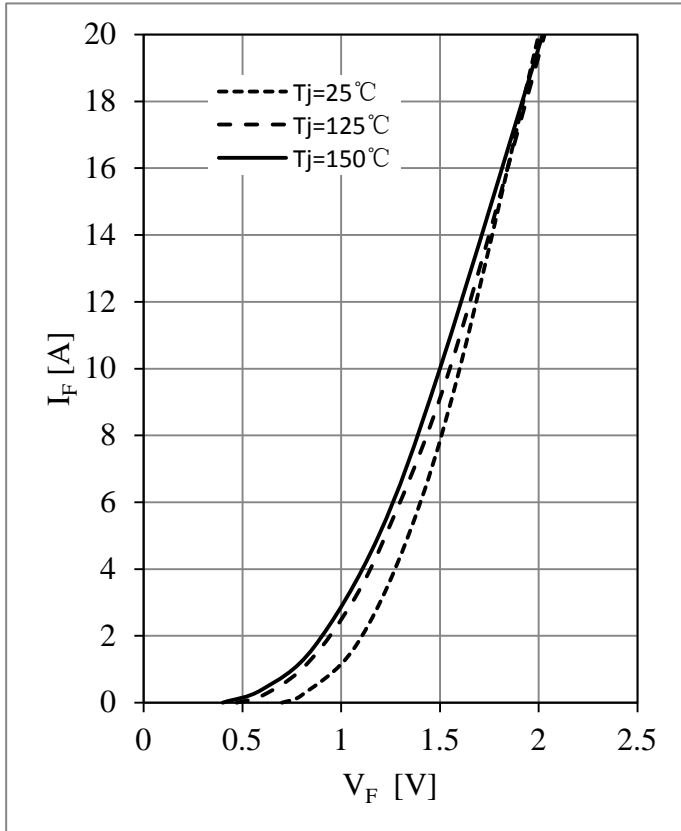


Fig 7. Diode-inverter Forward Characteristics

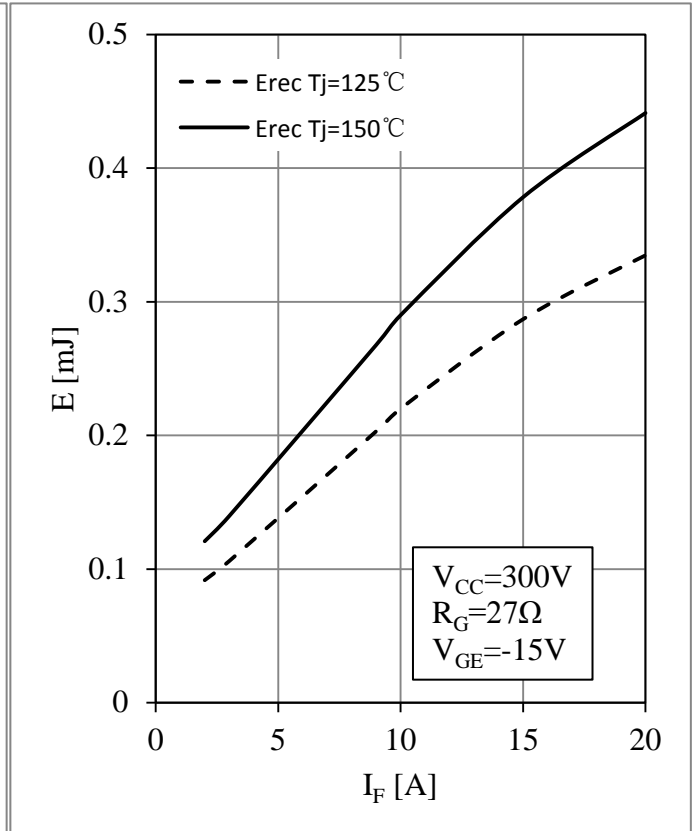


Fig 8. Diode-inverter Switching Loss vs. I_F

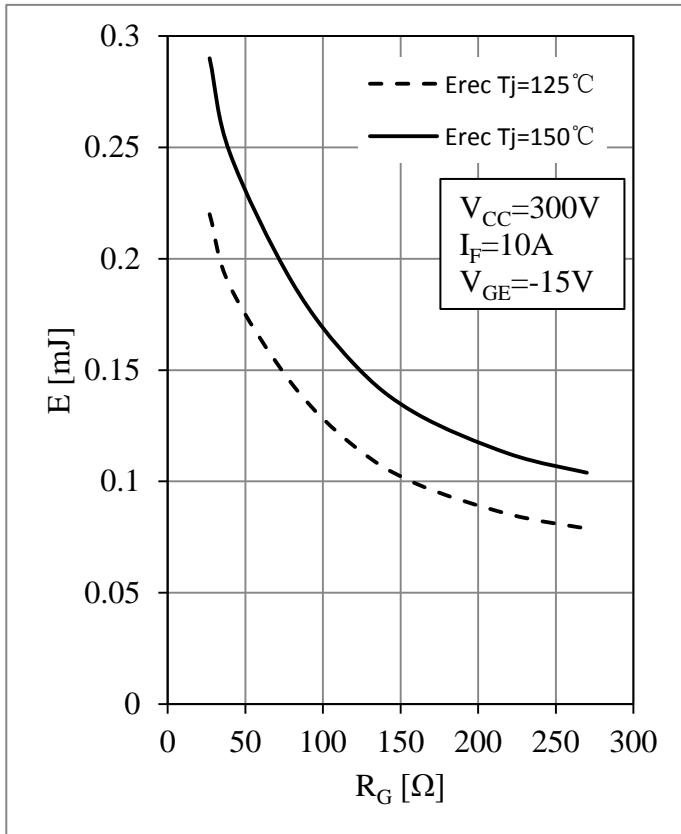


Fig 9. Diode-inverter Switching Loss vs. R_G

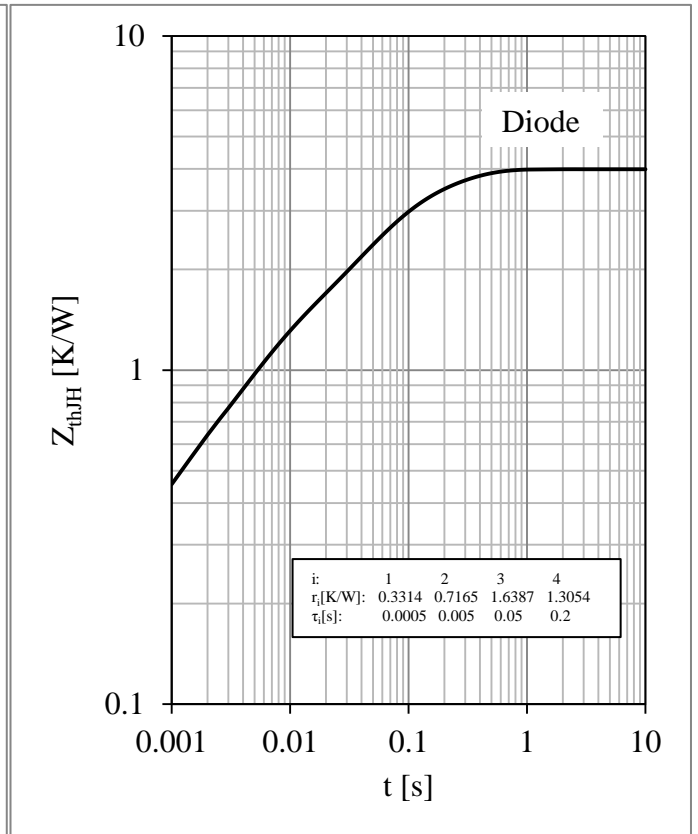


Fig 10. Diode-inverter Transient Thermal Impedance

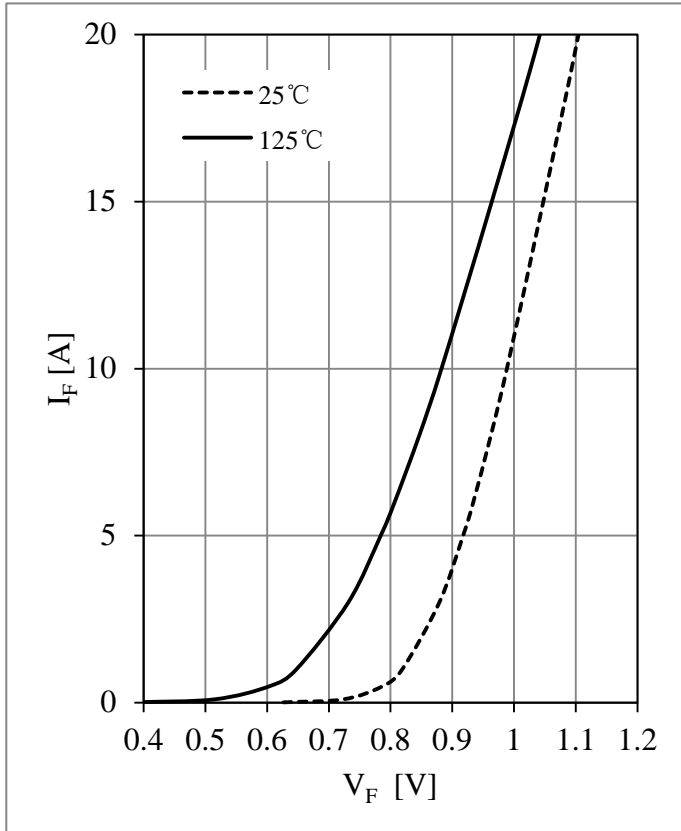


Fig 11. Diode-rectifier Forward Characteristics

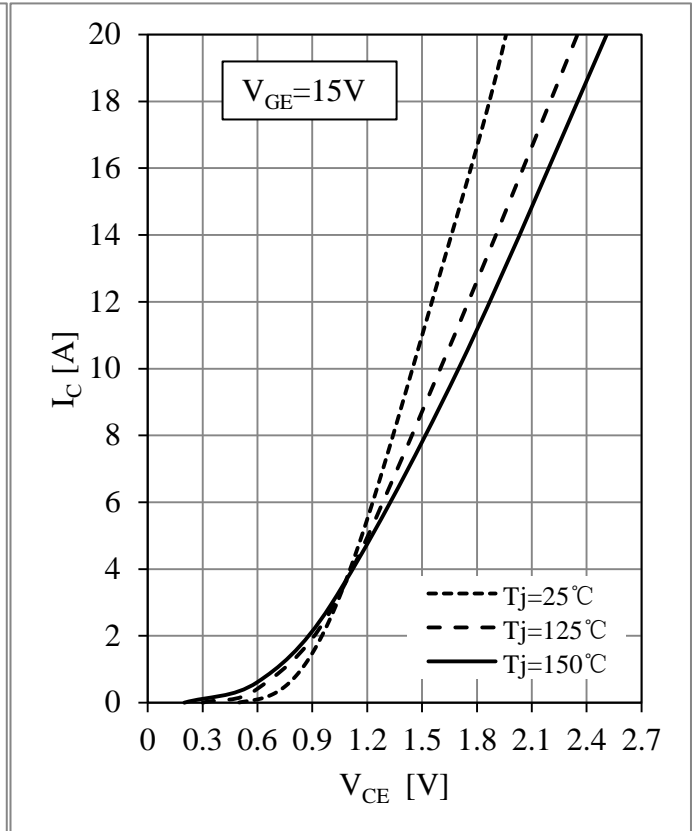


Fig 12. IGBT-brake Output Characteristics

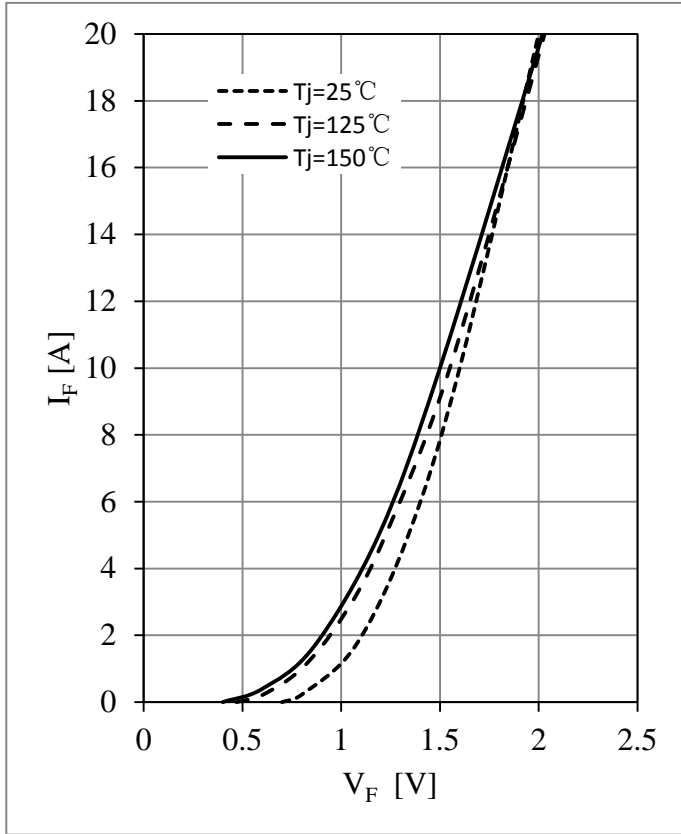


Fig 13. IGBT-brake Output Characteristics

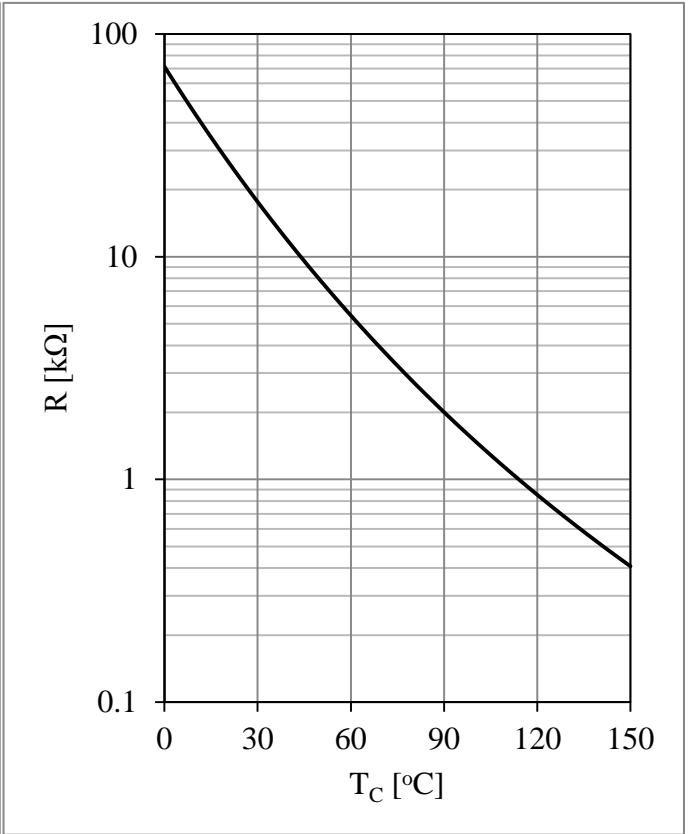
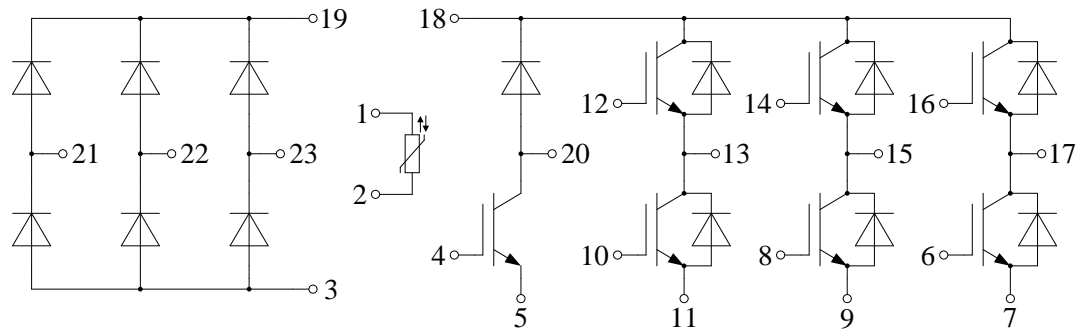


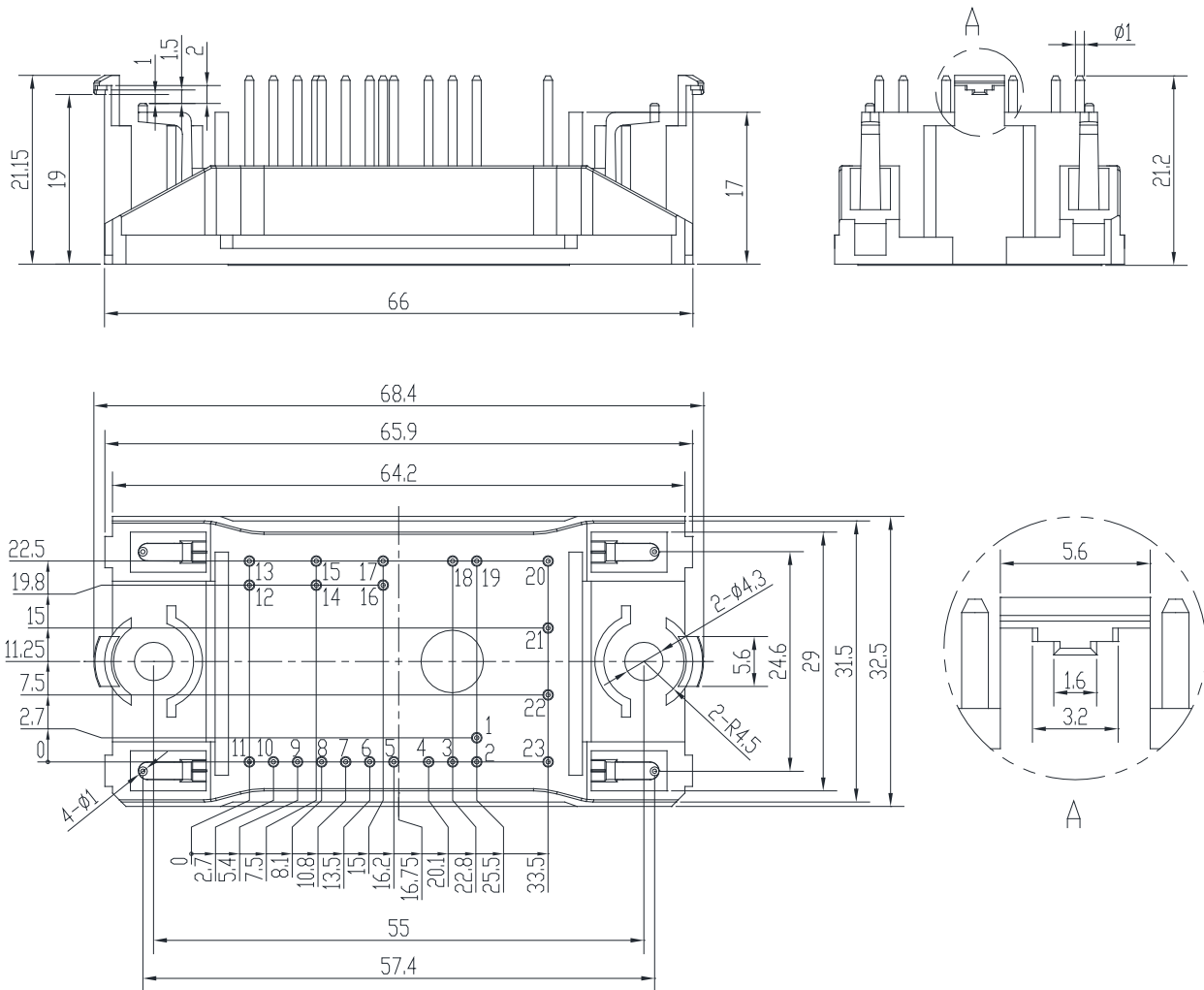
Fig 14. NTC Temperature Characteristic

Circuit Schematic



Package Dimensions

Dimensions in Millimeters



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